Overview

HP 250 G7 Notebook PC



- 1. Webcam LED
- 2. Webcam
- 3. Internal microphone
- 4. Touchpad
- 5. Touchpad button
- 6. Audio combo jack

Left

- 7. USB 3.1 Gen 1 port
- 8. USB 3.1 Gen 1 port
- 9. HDMI port (Cable not included)
- 10. RJ-45/Ethernet port
- 11. AC Smart Pin adapter plug
- 12. Power button

Overview



- 1. Security lock slot (Lock sold separately)
- 2. Optical drive (optional)
- 3. USB 2.0 port

Right

- 4. SD Card slot
- 5. Hard drive indicator LED
- 6. Power indicator LED

AT A GLANCE

Overview

- Preinstalled with Windows 10 versions or FreeDOS
- Choice of 8th or 7th Generation Intel® Core™ processors
- 15" (39.6 cm) diagonal FHD/HD Anti-Glare Display
- Choice of Integrated Intel® UHD Graphics 620, HD Graphics 620 or Switchable Discrete Graphics NVIDIA Geforce MX110
- Dark Ash Silver or Asteroid Silver color with texture pattern (Color options available in select countries)
- Up to 1 TB Hard Drive or 512 GB M.2 PCle Value Solid State Drive
- Weight starting at 1.78 Kgs (3.91 lbs)
- Security features including FW TPM 2.0 and security lock slot (Lock not included)
- Keyboard Full size textured island-style keyboard with numeric pad
- Touchpad with gestures support
- HP webcam with single digital microphone and HD (supporting WDR- Wide Dynamic Range) or VGA camera
- Two USB 3.1 (Gen 1) ports and One USB 2.0 port
- Wireless LAN (WLAN) up to 802.11ac to keep you connected
- Battery Life Up to 12 hours and 30 minutes

NOTE: See important legal disclosures for all listed specs in their respective features sections.



PRODUCT NAME

HP 250 G7 Notebook PC

OPERATING SYSTEM

Preinstalled Windows 10 Pro 64¹

Windows 10 Home 64¹

Windows 10 Home Single Language 64¹ Windows 10 Pro 64 (National Academic only)²

FreeDOS

Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, w is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com/.
 Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Upd Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

PROCESSOR

Intel® CoreTM i7-8565U processor with Intel® UHD Graphics 620 (1.8 GHz base frequency, up to 4.6 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores)^{3,4,5,6}

Intel® CoreTM i5-8265U with Intel® UHD Graphics 620 Graphics (1.6 GHz base frequency, up to 3.9 GHz with Intel® Turbo Boost Technology, 6 MB L3 cache, 4 cores) ^{3,4,5,6}

Intel® CoreTM i3-7020U with Intel® HD Graphics 620 (2.3 GHz, 3 MB cache, 2 cores)^{3,4,6}

Intel® Pentium® Silver Processor N5000 with Intel® UHD Graphics 605 (1.1 GHz base frequency, up to 2.7 GHz burst frequency, 4 I cache, 4 cores)^{3,4,6}

Intel® Celeron® Processor N4000 with Intel® UHD Graphics 600 (1.1 GHz base frequency, up to 2.6 GHz burst frequency, 4 MB cach cores)^{3,4,6}

Intel® CoreTM i7 + 8565U processor (CoreTM i7 and 16 GB Intel® OptaneTM memory) with Intel® UHD Graphics 620 (4.1 GHz base frequency, up to 4.6 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores)^{3,4,5,6,7}

Intel® CoreTM i5+ 8265U processor (CoreTM i5 and 16 GB Intel® OptaneTM memory) with Intel® UHD Graphics 620 (3.7 GHz base frequency, up to 3.9 GHz with Intel® Turbo Boost Technology, 6 MB L3 cache, 4 cores)^{3,4,5,6,7}

Intel® Celeron® N3060 with Intel® HD Graphics 400 (1.6 GHz base frequency, up to 2.48 GHz burst frequency, 2 MB cache, 2 cores) Intel® Pentium® Gold Processor 4417U with Intel® HD Graphics 610 (2.3 GHz base frequency, 2 MB cache, 2 cores)^{3,4,6}

Processor Family

8th Generation Intel® CoreTM i7 processor (i7-8565U)⁶
8th Generation Intel® CoreTM i5 processor (i5-8265U)⁶
7th Generation Intel® CoreTM i3 processor (i3-7020U)⁶
Intel® Pentium® processor (N5000, 4417U are Windows 10 only)⁶
Intel® Celeron® processor (N4000, N3060 are Windows 10 only)⁶

- 3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload anyour hardware and software configurations. Intel's numbering is not a measurement of higher performance.
- 4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
- 5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See http://www.intel.com/technology/turboboost for more information.

Features

b. In accordance with Microsoft's support policy, HP does not support the windows 8 or windows 7 operating system on production on forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

7. Intel® OptaneTM memory system acceleration does not replace or increase the DRAM in your system and requires configuration with an optional Intel® CoreTM i(5 or 7)+ processor.

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

Intel® HD Graphics 610^{8,9} Intel® UHD Graphics 620^{8,9} Intel® UHD Graphics 605^{8,9} Intel® UHD Graphics 600^{8,9} Intel® HD Graphics 400^{8,9}

Discrete

NVIDIA® GeForce® MX110 (2 GB DDR5 dedicated)9

Supports

Support HD decode, DX12, HDMI 1.4b

8. HD content required to view HD images.

9. Integrated graphics depends on processor. NVIDIA® OptimusTM technology requires an Intel processor, plus an NVIDIA® GeForc discrete graphics configuration and is available on Windows 10 Pro OS. With NVIDIA® OptimusTM technology, full enablement of a discrete graphics video and display features may not be supported on all systems (e.g. OpenGL applications will run on the integrated or the APU as the case may be).

DISPLAY

Internal

Non-Touch

39.6 cm (15.6") diagonal HD SVA eDP anti-glare WLED-backlit slim, 220 cd/m², 67% sRGB (1366 x 768)^{8, 10,11} 39.6 cm (15.6") diagonal FHD SVA eDP anti-glare WLED-backlit slim, 220 cd/m², 67% sRGB (1920 x 1080)^{8,10,11} **HDMI**

Port supports resolutions up to 1920 x 1200 external resolution @60 Hz

- 8. HD content required to view HD images.
- 10. Resolutions are dependent upon monitor capability, and resolution and color depth settings.
- 11. Sold separately or as an optional feature.

STORAGE AND DRIVES

Primary Storage

1 TB 5400 rpm SATA¹² 500 GB 7200 rpm SATA¹² 500 GB 5400 rpm SATA¹²

Primary M.2 Storage

128 GB SATA-3 TLC Solid State Drive¹²
256 GB SATA-3 TLC Solid State Drive¹²
256 GB PCIe Gen3x4 NVMe Value Solid State Drive¹²
512 GB PCIe Gen3x4 NVMe Value Solid State Drive¹²
16 GB Intel® OptaneTM Memory Cache⁷

12. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 7. Intel® OptaneTM memory system acceleration does not replace or increase the DRAM in your system and requires configuratio with an optional Intel® CoreTM i(5 or 7)+ processor.

MEMORY

Standard

Maximum Memory

16 GB DR4-2400 SDRAM¹⁴ 8 GB DR4-2133 SDRAM¹⁴ 8 GB DR4-1600 SDRAM¹⁴

Memory

16 GB DDR4-2400 SDRAM (2 X 8 GB) ¹⁴
8 GB DDR4-2400 SDRAM (1 x 8 GB)
8 GB DDR4-2400 SDRAM (2 x 4 GB) ¹⁴
4 GB DDR4-2400 SDRAM (1 x 4 GB)
8 GB DDR4-2133 SDRAM (1 x 8 GB)
8 GB DDR4-2133 SDRAM (2 x 4 GB) ¹⁴
4 GB DDR4-2133 SDRAM (1 x 4 GB)
4 GB DDR3L-1600 SDRAM (1 x 4 GB)
8 GB DDR3L-1600 SDRAM (1 x 8 GB)
4 GB DDR3L-2133 SDRAM (1 x 4 GB)
4 GB DDR3L-2133 SDRAM (1 x 4 GB)
4 GB DDR3L-2400 SDRAM (1 x 4 GB)

Memory Slots

2 SODIMM (Intel® 8th & 7th Generation Intel® CoreTM processor)
DDR4 PC4 SODIMMS, system runs at 2400 (Intel 7th Gen (KBL) runs at 2133)
Supports Dual Channel Memory¹³
Both slots are customer non-accessible / non-upgradeable

Maximum Memory

8 GB DDR4-2400 SDRAM (1 SODIMM Only)

Memory

8 GB DDR4-2400 SDRAM (1 x 8 GB) 4 GB DDR4-2400 SDRAM (1 x 4 GB) 6 GB DDR4-2400 SDRAM (2 GB + 4 GB)¹⁴ 8 GB DDR4-2400 SDRAM (2 x 4 GB)¹⁴

Features

Memory Slots

1 SODIMM (Intel® N5000, N4000 processor)

Single Channel Memory

Memory slot are customer non-accessible / non-upgradeable

Memory Slots

1 SODIMM (Intel® N3060 processor)

Single Channel Memory

Memory slot are customer non-accessible / non-upgradeable

13. Dual channel memory support only for 8th and 7th Generation Intel® CoreTM processors.

14. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to enscompatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

Wireless LAN (WLAN)

Realtek 802.11ac (2x2) Wi-Fi® and Bluetooth® 4.2 Combo (MU-MIMO supported)¹⁵

Realtek 802.11ac (1x1) and Bluetooth® 4.2 Combo¹⁵

Realtek 802.11b/g/n (1x1) and Bluetooth® 4.2 Combo¹⁵

Miracast

Compatible with Miracast-certified devices 16

Ethernet

Integrated 10/100/1000 GbE NIC

- 15. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited.
- 16. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

AUDIO/MULTIMEDIA

Audio

2 Integrated stereo speakers

Camera

HP TrueVision HD Camera^{8,11}

Webcam

VGA webcam¹¹¹⁷

Optical Drive

Optional DVD-Writer^{18,19}

- 8. HD content required to view HD images.
- 11. Sold separately or as an optional feature.
- 17. Internet access required.
- 18. Unit shipped with either "DVD+/-RW SuperMulti DL" or "DVD Writer Drive." Units undergoing repairs may be returned with a "DVD+/-RW SuperMulti DL."
- 19. HD-DVD disks cannot be played on this drive. No support for DVDRAM. Actual speeds may vary. Don't copy copyright protect materials. Double Layer discs can store more data than single layer discs; discs burned with this drive may not be compatible wit



many existing single-layer DVD drives and players.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Kevboard

Keyboard - Full size textured island-style keyboard with numeric pad

Pointing Device

Touchpad with multi-touch gesture support

Function Keys

F1 - Open " How to get help in Windows 10" webpage

F2 - Brightness Down

F3 - Brightness Up

F4 - Display Switching

F5 - Blank

F6 - Mute

F7 - Volume Down

F8 -Volume Up

F9 - Previous

F10 - Play/Pause

F11 - Next

F12 - Airplane mode

SOFTWARE AND SECURITY

Preinstalled Software

HP JumpStart

HP Documentation

HP Setup Integrated 00BE

HP SSRM

HP Audio Switch

HP Support Assistant²⁰

McAfee LiveSafeTM

Security Management

TPM 2.0²¹

Security lock slot (Lock sold separately)

20. HP Support Assistant requires Windows and Internet access.

21. Firmware TPM is version 2.0. Hardware TPM is v1.2, which is a subset of the TPM 2.0 specification version v0.89 as implemented by Intel Platform Trust Technology (PTT). TPM is version 2.0. Hardware TPM is v1.2, which is a subset of the TPM 2.0 specification version v0.89 as implemented by Intel Platform Trust Technology (PTT).

POWER

Power Supply

HP Smart 65 W External AC power adapter^{22, 24} HP Smart 65 W EM External AC power adapter^{22, 24} HP Smart 45 W External AC power adapter²²

Primary Battery

HP Long Life 3-cell, 41 Wh Li-ion^{23,24}
Support battery fast charging - Approximately 90% in 90 minutes

Power Cord

1M (3.28 feet) length power cord²²

Battery Life

Up to 12 hours and 30 minutes²⁵

Battery Weight

0.18 kg 0.39 lb

- 22. Availability may vary by country.
- 23. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 24. Recharges the battery up to 90% within 90 minutes when the system is off or in standby mode. Power adapter with a minim capacity of 65 watts is required. After charging has reached 90% capacity, charging will return to normal. Charging time may va 10% due to System tolerance.
- 25. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrewith time and usage. See http://www.bapco.com for additional details.

WEIGHTS & DIMENSIONS

Product Weight

Starting at 3.91 lb²⁶ Starting at 1.78 kg²⁶

Product Dimensions (w x d x h)

14.8 x 9.68 x 0.89 in 37.6 x 24.6 x 2.25 cm

26. Weight varies by configuration and components.

PORTS/SLOTS



Ports/Slots

2 USB 3.1 Gen 1 1 USB 2.0 1 HDMI v1.4b²⁷ 1 RJ-45 1 AC power 1 Headphone/microphone combo jack

Expansion Slots

1 multi-format digital media reader Supports SD, SDHC, SDXC

27. HDMI cable sold separately.

SERVICE AND SUPPORT

HP Services offers 1-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc. 28

28. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, vis http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable loc laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

Technical Specifications

SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)

Nominal Operating Voltage 19.5 V Average Operating Power Win 10 Integrated graphics 6.39W

Discrete < 65W

Max Operating Power UMA < 45W

Temperature

Operating 32° to 95° F (0° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (writing optical)

Non-operating -4° to 140° F (-20° to 60° C)

Relative Humidity

Operating 10% to 90%, non-condensing

Non-operating 5% to 95%

Shock

Operating 40 G, 2 ms duration, half-sine Non-operating 240 G, 2 ms duration, half-sine

Random Vibration

Operating 1.043 grms
Non-operating 3.5 grms

Planned Industry Standard Certifications

UL Yes
CSA No
FCC Compliance Yes
ENERGY STAR® Yes²⁹

EPEAT® 2019 Yes. Silver in U.S.³⁰

ICES Yes Australia / Yes NZ A-Tick Compliance Yes CCC Yes Japan VCCI Compliance Yes KC Yes **BSMI** Yes **CE Marking Compliance** Yes **BNCI or BELUS** Yes CIT Yes GOST Yes Saudi Arabian Compliance (ICCP) Yes SABS Yes

29. Configurations of the HP 250 G7 that are ENERGY STAR® certified are identified as HP 250 G7 ENERGY STAR on HP websites and or http://www.energystar.gov.

30. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit http://www.epeat.net formore information.

DISPLAYS

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Technical Specifications

15.6" diagonal HD WLED AntiGlare (1366x768) slim- $(W \times H \times D)$ flat (3.2mm) SVA, eDP

Outline Dimensions 360.0 x 224.3mm max

Active Area 344.2 x 193.5 Weight 420 max. **Diagonal Size** 15.6 (inch) **Thickness** 3.2mm max Interface eDP 1.2 (1 lane) **Surface Treatment** Anti-glare (AG)

Touch Enabled NO

Contrast Ratio 300:1 (typ) **Refresh Rate** 60Hz **Brightness** 220 nit typ

Format 1366 x 768 (HD) **Pixel Resolution**

Configuration RGB

Backlight LED **Color Gamut Coverage** 45%

Color Depth 6 bits (Hi FRC) **Viewing Angle** SVA 40/40/15/30

15.6" diagonal FHD WLED Outline Dimensions AntiGlare (1920x1080) slim-flat (3.2mm) SVA, eDP

360.0 x 224.3mm max $(W \times H \times D)$

Active Area 344.16 x 193.59 Weight 370g max. **Diagonal Size** 15.6 (inch) **Thickness** 3.2mm max Interface eDP 1.2

Surface Treatment Anti-glare (AG)

Touch Enabled NO

Contrast Ratio 300:1 (typ) **Refresh Rate** 60Hz **Brightness** 220 nit typ

Format 1920 x 1080 (FHD) **Pixel Resolution**

Configuration RGB

Backlight LED **Color Gamut Coverage** 45% **Color Depth** 6 bits + FRC **Viewing Angle** SVA 45/45/25/35

STORAGE AND DRIVES

Technical Specifications

500 GB 5400 rpm SATA

Dard Drive

Drive Weight92g(0.20lb)Rotation speed5400 rpmCache BufferUp to 128MB

Height 7.0 +/- 0.2 mm (0.28 +/-.008 in)

Width 69.85 +/- 0.25 mm (2.750 +/- 0.010 in)

Interface ATA-8, SATA 3.0

Transfer Rate 600 MB/s

Seek Time Single Track: 2 ~ 1.5 ms

Average: 11 ~ 16 ms Maximum: 18 ~ 22 ms

Logical Blocks976,773,168Operating Temperature0° to 60°CSecurity FeaturesATA Security

Features S.M.A.R.T., NCQ, Ultra DMA

500 GB 7200 rpm SATA Hard Drive Drive Weight92g(0.20lb)Rotation speed7200 rpmCache BufferUp to 128MB

Height 7.0 +/- 0.2 mm (0.28 +/-.008 in)

Width 69.85 +/- 0.25 mm (2.750 +/- 0.010 in)

Interface ATA-8, SATA 3.0

Transfer Rate 600 MB/s

Seek Time Single Track: 2 ~ 1.5 ms

Average: 11 ~ 13 ms Maximum: 18 ~ 22 ms

Logical Blocks976,773,168Operating Temperature0° to 60°CSecurity FeaturesATA Security

Features S.M.A.R.T., NCQ, Ultra DMA

Technical Specifications

1 TB 5400 rpm SATA Hard Drive Weight Drive

Drive Weight92g(0.20lb)Rotation speed7200 rpmCache BufferUp to 128MB

Height 7.0 +/- 0.2 mm (0.28 +/-.008 in)

Width 69.85 +/- 0.25 mm (2.750 +/- 0.010 in)

Interface ATA-8, SATA 3.0

Transfer Rate 600 MB/s

Seek Time Single Track: 2 ~ 1.5 ms

Average: 11 ~ 16 ms Maximum: 18 ~ 22 ms

Logical Blocks976,773,168Operating Temperature0° to 60°CSecurity FeaturesATA Security

Features S.M.A.R.T., NCQ, Ultra DMA

128 GB 2280 M2 SATA-3 TLC Solid State Drive
 Drive Weight
 0.02 lb (10 g)

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate 550MB/s
Logical Blocks 250,069,680

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Security Features ATA Security
Features DIPM; TRIM; DEVSLP

256 GB 2280 M2 SATA-3 TLC Solid State Drive

 Drive Weight
 0.02 lb (10 g)

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate 550MB/s **Logical Blocks** 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Security Features ATA Security

Features DIPM; TRIM; DEVSLP

Technical Specifications

256 GB 2280 M2 PCIe NVMe Value Solid State Drive Form Factor M.2 2280
Capacity 256 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

Weight 0.01 lb (6 g) ~ 0.02 lb (10 g)

Interface PCIe NVMe Gen3x2

Maximum Sequential Up To 1500 MB/s

Read

Maximum Sequential

Write

Up To 1000 MB/s

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features DIPM; TRIM; DEVSLP

512 GB 2280 M2 PCIe NVMe Value Solid State Drive Form Factor M.2 2280
Capacity 512 GB
NAND Type TLC

Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Interface PCIe NVMe Gen3x2
Maximum Sequential Up To 1600 MB/s

Read

Maximum Sequential

Write

Up To 1200 MB/s

Logical Blocks 1,000,236,384

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features DIPM; TRIM; DEVSLP

16 GB Intel®OptaneTM
Solution PCIe Gen3x2 M.2
SSD

Form Factor M.2 2280
Capacity 16 GB
NAND Type 3D Xpoint
Height 0.09 in (2.3 r

Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3x2

Maximum Sequential 1350MB/s

Read

Maximum Sequential 290MB/s

Write

Logical Blocks 31,257,387

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

NETWORKING/COMMUNICATIONS WLAN

Technical Specifications

Realtek RTL8822BE 802.11 ac 2x2 WiFi + Bluetooth®4.2 Combo Adapter (MU-MIMO supported) Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac

Interoperability Wi-Fi® certified **Frequency Band** 802.11b/q/n

• 2.402 - 2.482 GHz

802.11a/n

• 4.9 - 4.95 GHz (Japan)

5.15 - 5.25 GHz
5.25 - 5.35 GHz
5.47 - 5.725 GHz

• 5.825 - 5.850 GHz

Data Rates ● 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz,

40MHz, and 80MHz)

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security³

 IEEE and WiFi® compliant 64 / 128 bit WEP encryption for a/b/g mode only

• AES-CCMP: 128 bit in hardware

802.1x authentication

 WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

• IEEE 802.11i

 Cisco Certified Extensions, all versions through CCX4 and CCX Lite

WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming Output Power² IEEE 802.11 compliant roaming between access points

802.11b: +14dBm minimum

• 802.11g: +12dBm minimum

• 802.11a: +12dBm minimum

802.11n HT20(2.4GHz): +12dBm minimum
802.11n HT40(2.4GHz): +12dBm minimum
802.11n HT20(5GHz): +10dBm minimum
802.11n HT40(5GHz): +10dBm minimum

• 802.11ac VHT80(5GHz): +10dBm minimum

Power Consumption Transmit: 2.0 W (max)

Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)
Idle mode: 50 mW (WLAN unassociated)
Connect Standby: 10 mW (WLAN+BT)

Radio disabled: 8 mW



Technical Specifications

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230: 2.3 x 22.0 x 30.0 mm

 Weight
 Type 2230: 2.8g

 Operating Voltage
 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Amber - Radio OFF; LED White - Radio ON

Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/q (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2 Compliant
Frequency Band 2402 to 2480 MHz
Number of Available Legacy: 0~79 (1 MHz/0

Number of Available Legacy: 0~79 (1 MHz/CH)
Channels BLE: 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps signaling data rate up to 2.17 Mbps

BLE: 1 Mbps data signaling data rate¹ up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 4 dBm for BR and EDR.

Realtek RTL8821CE 802.11ac 1x1 WiFi + Bluetooth® 4.2 Combo (MU-MIMO supported) Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac

Technical Specifications

Interoperability Wi-Fi® certified **Frequency Band** 802.11b/q/n

2.402 - 2.482 GHz

802.11a/n

• 4.9 - 4.95 GHz (Japan)

• 5.15 - 5.25 GHz

• 5.25 - 5.35 GHz

5.47 - 5.725 GHz

• 5.825 - 5.850 GHz

• 802.11b: 1, 2, 5.5, 11 Mbps **Data Rates**

> • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security³ IEEE and WiFi® compliant 64 / 128 bit WEP encryption

for a/b/g mode only

• AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP,

and AES.

WPA2 certification

• IEEE 802.11i

Cisco Certified Extensions, all versions through CCX4

and CCX Lite

WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming Output Power² IEEE 802.11 compliant roaming between access points

• 802.11b: +14dBm minimum 802.11g: +12dBm minimum

802.11a: +12dBm minimum

• 802.11n HT20(2.4GHz): +12dBm minimum

• 802.11n HT40(2.4GHz): +12dBm minimum

• 802.11n HT20(5GHz): +10dBm minimum

802.11n HT40(5GHz): +10dBm minimum

802.11ac VHT80(5GHz): +10dBm minimum"

Power Consumption

Transmit: 2.0 W (max)

Receive mode: 1.6 W (max) Idle mode (PSP): 180 mW (WLAN Associated)

Idle mode: 50 mW (WLAN unassociated)

Connect Standby: 10 mW Radio disabled: 8 mW

Power Management

ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³

802.11b, 1Mbps: -93.5dBm maximum 802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum

Technical Specifications

802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230: 2.3 x 22.0 x 30.0 mm

 Weight
 Type 2230: 2.8g

 Operating Voltage
 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber - Radio OFF; LED White - Radio ON

4. Check latest software/driver release for updates on supported security features.

5. Maximum output power may vary by country according to local regulations.

Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2 Compliant
Frequency Band 2402 to 2480 MHz

Number of Available Channels

Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps data signaling data rate¹ up to 2.17 Mbps

BLE: 1 Mbps data signaling data rate¹ up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 4 dBm for BR and EDR.

Realtek Ethernet (10/100/1000)

Ethernet Features 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)

100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40)

Auto-Negotiation (Automatic Speed Selection)

Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100

Mbit/s

IEEE 802.1p QoS (Quality of Service) Support

IEEE 802.1q VLAN support

IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)

Technical Specifications

IEEE 802.3az EEE (Energy Efficient Ethernet)

Jumbo Frame 9K

Auto MDI/MDIX Crossover cable detection

Power Management ACPI compliant - multiple power modes

Situation-sensitive features reduce power consumption

Advanced link down power saving for reducing link down power consumption

Performance Features TCP/IP/UDP Checksum Offload (configurable)

Protocol Offload (ARP & NS)

Large send offload and Giant send offload

Receiving Side Scaling

Manageability Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft

Wake-Up Frame); Wake-on-LAN from off (Magic Packet only)

PXE 2.1 Remote Boot

Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x,

clause 30))

Comprehensive diagnostic and configuration software suite

Virtual Cable Doctor for Ethernet cable status

Interface PCI Express 1.1 to support ASPM L1

NIC Device Driver Name Realtek PCIe GBE Ethernet Family Controller

POWER

HP 65 W Smart AC adapter

Dimensions $(H \times W \times D)$

108 x 47 x 37.4mm

Weight

250a

Input

Input 100 to 240 VAC

Input Efficiency

88.0 % at 115 VAC and 89.0 % at 230VAC

Input frequency range

50~ 60 Hz

Max. 1.7 A at 90 VAC

Input AC current

65W

Output **Output power**

> **DC** output 19.5V

Hold-up time 5ms at 115 Vac input

> The power supply shall limit the maximum steady state output current to an average current of 11

Amperes.

Connector

4.5mm Barrel Type

Output current limit

Environmental Design

Operating temperature

32° to 95° F (0° to 35° C)

Non-operating (storage)

temperature

-4° to 185° F (-20° to 85° C)

Altitude

The power supply can be operated at 5.000 m

above sea level

Humidity

The power supply shall withstand without

degradation with 95% relative humidity, noncondensing, both operating and non-operating

EMI and Safety Certifications

*CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B,

CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200.000 hours at 25°C ambient condition.

45 W AC adapter

Dimensions $(H \times W \times D)$

95x40x26.5mm

Weight

200g

Technical Specifications

Input Input 100 to 240 VAC

> **Input Efficiency** 87.8 % at 115 VAC and 88.5 % at 230VAC

Input frequency range 50~ 60 Hz

Input AC current Max. 1.4 A at 90 VAC

Output **Output power** 45W

> **DC** output 19.5V

Hold-up time 5ms at 115 Vac input

Output current limit The power supply shall limit the maximum steady

state output current to an average current of 8

Amperes.

Connector 4.5mm Barrel Type,

Environmental Design Operating 32° to 95° F (0° to 35° C) temperature

Non-operating (storage)

temperature

-4° to 185° F (-20° to 85° C)

Altitude The power supply can be operated at 5,000 m

above sea level

Humidity The power supply shall withstand without

> degradation with 95% relative humidity, noncondensing, both operating and non-operating.

EMI and Safety *CE Mark - full compliance with LVD and EMC directives

Certifications * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV;

Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B,

CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

HP 65W Smart AC adapter (EM) **Dimensions** $(H \times W \times D)$

102x55x30mm

Weight 270q

Input Input 100 to 240 VAC

> **Input Efficiency** 88.0 % at 115 VAC and 89.0 % at 230VAC

Input frequency range 50~ 60 Hz

Input AC current Max. 1.7 A at 90 VAC

Output **Output power** 65W

> DC output 19.5V

Hold-up time 5ms at 115 Vac input

Output current limit The power supply shall limit the maximum steady

state output current to an average current of 11

Amperes.

Connector

4.5mm Barrel Type

Environmental Design Operating

32° to 95° F (0° to 35° C) temperature

Non-operating (storage)

temperature

-4° to 185° F (-20° to 85° C)

Altitude

above sea level

Humidity The power supply shall withstand without

degradation with 95% relative humidity, non-

The power supply can be operated at 5,000 m

condensing, both operating and non-operating.

EMI and Safety Certifications

*CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV;

Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B,

CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

Technical Specifications

HP 3-cell Li-Ion

Dimensions (H x W x L)

6.0 x 186.85 x 90.2 mm (0.236 x 7.35 x 3.55 inch)

3cell Lithium-Ion Polymer cell / 515974

Long Life - Fast Charge (41 Weight WHr)

0.18 kg (0.39 lb) Cells/Type

Voltage 11.4V **Amp-hour capacity** 3.6Ah **Watt-hour capacity** 41Wh

Operating (Charging) 32° to 113° F (0° to 45° C) Operating (Discharging) 14° to 122° F (-10° to 60° C)

Optional Travel Battery

Available

No

HP 3-cell Li-Ion Long Life - Fast Charge (41 Weight WHr)

Dimensions 6.0 x 186.85 x 90.2 mm (0.236 x 7.35 x 3.55 inch)

0.19 kg (0.41 lb)

Cells/Type 3cell Lithium-Ion Prismatic cell / 496080

Voltage 11.55V

Amp-hour capacity 3.615Ah/3.63Ah

Watt-hour capacity 41Wh

Operating (Charging) 32° to 113° F (0° to 45° C) Operating (Discharging) 14° to 122° F (-10° to 60° C)

Optional Travel Battery

Available

No

Country of Origin

China

title

Category	Description	Part Number
Cases	HP Essential Top Load Case	H2W17AA#xxx
	HP Essential Backpack (up to 15.6")	H1D24AA
	HP Essential Messenger Case (up to 17.3")	H1D25AA
Docking	HP 3005PR USB3 Port Replicator	Y4H06AA
•	HP USB Travel Dock	TOK30AA
	HP Monitor Stand	M9X76AA
Input / Output	HP Slim USB Keyboard and Mouse	Т6Т8ЗАА
input / Output	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP 3-Button USB Laser Mouse	H4B81AA
	HP USB Travel Mouse	G1K28AA
	HP Comfort Grip Wireless Mouse	H2L63AA
	HP Ultra Mobile Wireless Mouse	H6F25AA#xxx
	HP HDMI to DVI Adapter	F5A28AA
	HP Stereo USB Headset	T1A67AA
	HP Stereo 3.5mm Headset	T1A66AA
Power	HP 45W Smart AC Adapter 4.5mm	H6Y88AA#XXX
	HP 65W Smart AC Adapter	H6Y89AA#xxx
	HP 65W Slim AC Adapter	H6Y82AA#xxx
Storage	HP External USB Optical Drive	F2B56AA
Memory	HP 4GB 2666Mhz DDR4	4VN05AA
	HP 8GB 2666Mhz DDR4	4VN06AA
Displays	HP S140u 14-inch Portable Display	G8R65AA
	HP ProDisplay P223 21-5inch Monitor	X7R61AA
	HP ProDisplay P232 23-inch Monitor	K7X31AA
	HP ProDisplay P240va 23.8-inch Monitor	N3H14AA
	HP EliteDisplay S14 14-inch USB-C Portable Monitor	3HX46AA



Summary of Changes

Date of change:	Version History:		Description of change:
March 1, 2019	From v1 to v2	Removed	USB-C Travel Dock
March 4, 2019	From v2 to v3	Removed	Battery Life
March 18, 2019	From v3 to v4	Added	Battery Life
April 9, 2019	From v4 to v5	Update	Memory section
May 17, 2019	From v5 to v6	Update	Memory section
June 13, 2019	From v6 to v7	Updated	EPEAT
July 3, 2019	From v7 to V8	Updated	Processors

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